### **INTEGRATED CIRCUITS**

## DATA SHEET

74HC74; 74HCT74

Dual D-type flip-flop with set and reset; positive-edge trigger

Product specification Supersedes data of 1998 Feb 23 2003 Jul 10





### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

#### **FEATURES**

- Wide supply voltage range from 2.0 to 6.0 V
- · Symmetrical output impedance
- · High noise immunity
- · Low power dissipation
- · Balanced propagation delays
- ESD protection: HBM EIA/JESD22-A114-A exceeds 2000 V MM EIA/JESD22-A115-A exceeds 200 V.

#### **GENERAL DESCRIPTION**

The 74HC/HCT74 is a high-speed Si-gate CMOS device and is pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT74 are dual positive-edge triggered, D-type flip-flops with individual data (D) inputs, clock (CP) inputs, set  $(\overline{S}D)$  and reset  $(\overline{R}D)$  inputs; also complementary Q and  $\overline{Q}$  outputs.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

### **QUICK REFERENCE DATA**

GND = 0 V;  $T_{amb} = 25 \, ^{\circ}C$ ;  $t_r = t_f = 6 \, \text{ns}$ 

SYMBOL	PARAMETER	CONDITIONS	TYP	TYPICAL	
STWIBUL	PARAMETER	CONDITIONS	НС	нст	UNIT
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay	$C_L = 15 \text{ pF}; V_{CC} = 5 \text{ V}$			
	nCP to nQ, $n\overline{Q}$		14	15	ns
	$n\overline{S}D$ to $nQ$ , $n\overline{Q}$		15	18	ns
	$n\overline{R}D$ to $nQ$ , $n\overline{Q}$		16	18	ns
f <sub>max</sub>	maximum clock frequency		76	59	MHz
C <sub>I</sub>	input capacitance		3.5	3.5	pF
C <sub>PD</sub>	power dissipation capacitance per flip-flop	notes 1 and 2	24	29	pF

#### **Notes**

1.  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

fo = output frequency in MHz;

C<sub>L</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in Volts;

N = total load switching outputs;

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

2. For 74HC74 the condition is  $V_I = GND$  to  $V_{CC}$ .

For 74HCT74 the condition is  $V_I = GND$  to  $V_{CC} - 1.5 V$ .

## Dual D-type flip-flop with set and reset; positive-edge trigger

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### **FUNCTION TABLES**

Table 1 See note 1

	INPUT				PUT
SD	RD	СР	D	Q	Q
L	Н	Х	Х	Н	L
Н	L	X	Х	L	Н
L	L	X	X	Н	Н

### Table 2 See note 1

	INPUT				PUT	
SD	RD	СР	D	Qn+1 Qn+1		
Н	Н	1	L	L	Н	
Н	Н	1	Н	Н	L	

#### Note

1. H = HIGH voltage level;

L = LOW voltage level;

X = don't care;

 $\uparrow$  = LOW-to-HIGH CP transition;

Qn+1 = state after the next LOW-to-HIGH CP transition.

### **ORDERING INFORMATION**

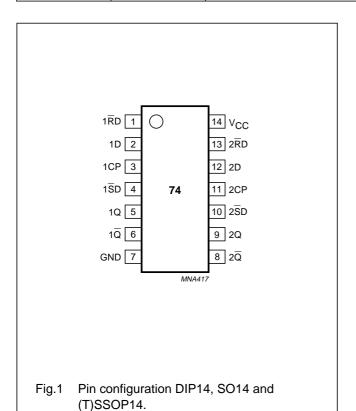
			PACKAGE		
TYPE NUMBER	TEMPERATURE RANGE	PINS	PACKAGE	MATERIAL	CODE
74HC74N	–40 to +125 °C	14	DIP14	plastic	SOT27-1
74HCT74N	–40 to +125 °C	14	DIP14	plastic	SOT27-1
74HC74D	–40 to +125 °C	14	SO14	plastic	SOT108-1
74HCT74D	–40 to +125 °C	14	SO14	plastic	SOT108-1
74HC74DB	–40 to +125 °C	14	SSOP14	plastic	SOT337-1
74HCT74DB	–40 to +125 °C	14	SSOP14	plastic	SOT337-1
74HC74PW	–40 to +125 °C	14	TSSOP14	plastic	SOT402-1
74HCT74PW	–40 to +125 °C	14	TSSOP14	plastic	SOT402-1
74HC74BQ	–40 to +125 °C	14	DHVQFN14	plastic	SOT762-1
74HCT74BQ	-40 to +125 °C	14	DHVQFN14	plastic	SOT762-1

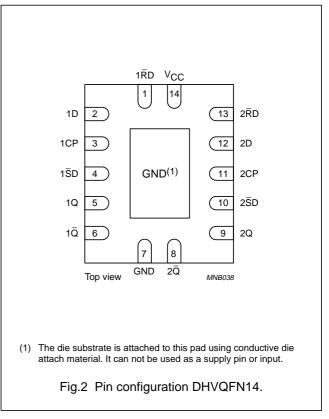
### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

#### **PINNING**

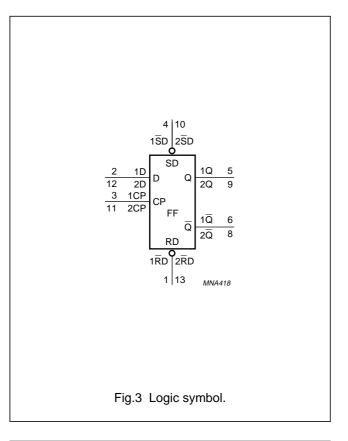
PIN	SYMBOL	DESCRIPTION
1	1RD	asynchronous reset-direct input (active LOW)
2	1D	data input
3	1CP	clock input (LOW-to-HIGH, edge-triggered)
4	1SD	asynchronous set-direct input (active LOW)
5	1Q	true flip-flop output
6	1Q	complement flip-flop output
7	GND	ground (0 V)
8	2Q	complement flip-flop output
9	2Q	true flip-flop output
10	2SD	asynchronous set-direct input (active LOW)
11	2CP	clock input (LOW-to-HIGH, edge-triggered)
12	2D	data input
13	2RD	asynchronous reset-direct input (active LOW)
14	V <sub>CC</sub>	positive supply voltage

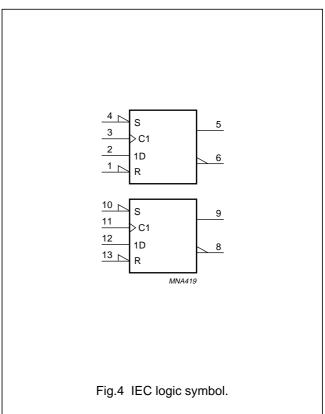


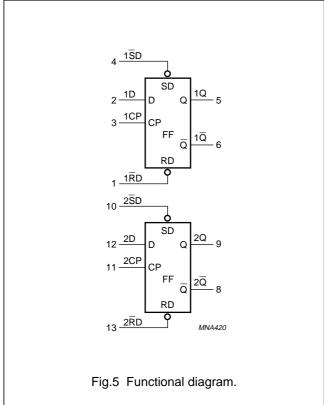


### Dual D-type flip-flop with set and reset; positive-edge trigger

### 74HC74; 74HCT74

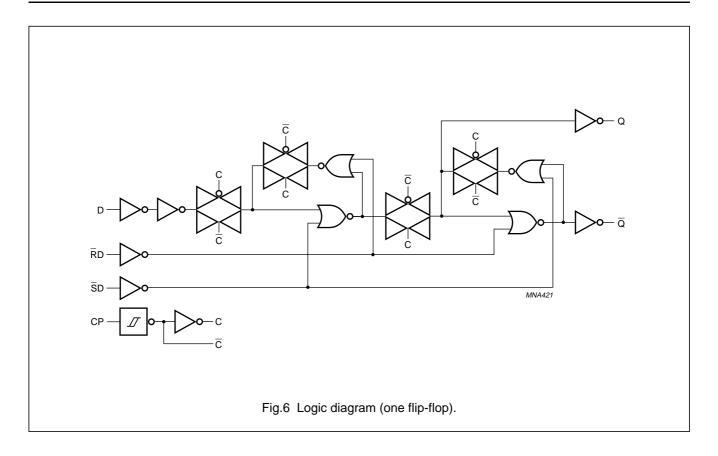






# Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74



### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

#### RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	74HC74			74HCT74			UNIT
STWIBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	UNII
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	_	V <sub>CC</sub>	0	_	V <sub>CC</sub>	V
Vo	output voltage		0	_	V <sub>CC</sub>	0	_	V <sub>CC</sub>	V
T <sub>amb</sub>	operating ambient temperature		-40	+25	+125	-40	+25	+125	°C
t <sub>r</sub> , t <sub>f</sub>	input rise and fall	V <sub>CC</sub> = 2.0 V	_	_	1000	_	_	500	ns
	times	V <sub>CC</sub> = 4.5 V	_	6.0	500	_	6.0	500	ns
		V <sub>CC</sub> = 6.0 V	_	_	400	_	_	500	ns

### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CC</sub>	supply voltage		-0.5	+7.0	V
I <sub>IK</sub>	input diode current	$V_1 < -0.5 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V};$ note 1	_	±20	mA
I <sub>OK</sub>	output diode current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V};$ note 1	_	±20	mA
Io	output source or sink current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$ ; note 1	_	±25	mA
I <sub>CC</sub> , I <sub>GND</sub>	V <sub>CC</sub> or GND current		_	±100	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	power dissipation	$T_{amb} = -40 \text{ to } +125 ^{\circ}\text{C}; \text{ note } 2$	_	500	mW

#### **Notes**

- 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
- 2. For SO14 packages: above 70 °C derate linearly with 8 mW/K.

For SSOP14 and TSSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.

For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

For DIP14 packages: above 70 °C derate linearly with 12 mW/K.

## Dual D-type flip-flop with set and reset; positive-edge trigger

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### **DC CHARACTERISTICS**

### Family 74HC

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

CVMDOL	PARAMETER	TEST CONDIT	IONS		TVD	MAX.	UNIT
SYMBOL		WAVEFORMS	V <sub>CC</sub> (V)	MIN.	TYP.		
T <sub>amb</sub> = -40 to	• <b>+85</b> ° <b>C</b> ; note 1		'		'	1	'
V <sub>IH</sub>	HIGH-level input		2.0	1.5	1.2	_	V
	voltage		4.5	3.15	2.4	_	V
			6.0	4.2	3.2	_	V
V <sub>IL</sub>	LOW-level input voltage		2.0	_	0.8	0.5	V
			4.5	_	2.1	1.35	V
			6.0	_	2.8	1.8	V
V <sub>OH</sub>	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$					
	voltage	$I_{O} = -4.0 \text{ mA}$	4.5	3.84	4.32	_	V
		$I_{O} = -5.2 \text{ mA}$	6.0	5.34	5.81	_	V
V <sub>OL</sub>	LOW-level output	$V_I = V_{IH}$ or $V_{IL}$					
	voltage	$I_{O} = 4.0 \text{ mA}$	4.5	_	0.15	0.33	V
		I <sub>O</sub> = 5.2 mA	6.0	_	0.16	0.33	V
I <sub>LI</sub>	input leakage current	$V_I = V_{CC}$ or GND	6.0	_	_	±1.0	μΑ
I <sub>CC</sub>	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	6.0	_	-	40	μΑ
T <sub>amb</sub> = -40 to	+125 °C				•	1	'
V <sub>IH</sub>	HIGH-level input		2.0	1.5	_	_	V
	voltage		4.5	3.15	_	_	V
			6.0	4.2	_	_	V
V <sub>IL</sub>	LOW-level input voltage		2.0	_	_	0.5	V
			4.5	_	_	1.35	V
			6.0	_	_	1.8	V
V <sub>OH</sub>	HIGH-level output	$V_I = V_{IH}$ or $V_{IL}$					
	voltage	$I_{O} = -4.0 \text{ mA}$	4.5	3.7	_	_	V
		$I_{O} = -5.2 \text{ mA}$	6.0	5.2	_	_	V
V <sub>OL</sub>	LOW-level output	$V_I = V_{IH}$ or $V_{IL}$					
	voltage	I <sub>O</sub> = 4.0 mA	4.5	_	_	0.4	V
		I <sub>O</sub> = 5.2 mA	6.0	_	_	0.4	V
I <sub>LI</sub>	input leakage current	$V_I = V_{CC}$ or GND	6.0	_	_	±1.0	μΑ
I <sub>CC</sub>	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	6.0	_	-	80	μΑ

### Note

1. All typical values are measured at  $T_{amb}$  = 25 °C.

## Dual D-type flip-flop with set and reset; positive-edge trigger

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Family 74HCT

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

CVMDOL	DADAMETER	TEST CONDITIONS		MIN.	TVD	MAY	
SYMBOL	PARAMETER	WAVEFORMS	V <sub>CC</sub> (V)	WIIIN.	TYP.	MAX.	UNIT
$T_{amb} = -40 \text{ to}$	+85 °C; note 1				•	•	•
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	1.6	_	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	_	1.2	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ ; $I_O = -4.0$ mA	4.5	3.84	4.32	_	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = 4.0 \text{ mA}$	4.5	0.33	0.15	_	V
ILI	input leakage current	$V_I = V_{CC}$ or GND	5.5	_	_	±1.0	μΑ
I <sub>CC</sub>	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	5.5	_	_	40	μА
$\Delta I_{CC}$	additional quiescent supply current per input	$V_I = V_{CC} - 2.1 \text{ V other}$ inputs at $V_{CC}$ or GND; $I_O = 0$	4.5 to 5.5	_	100	450	μΑ
$T_{amb} = -40 \text{ to}$	+125 °C		•			•	
V <sub>IH</sub>	HIGH-level input voltage		4.5 to 5.5	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage		4.5 to 5.5	_	_	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH} \text{ or } V_{IL};$ $I_O = -4.0 \text{ mA}$	4.5	3.7	_	_	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$ ; $I_O = 4.0$ mA	4.5	_	_	0.4	V
ILI	input leakage current	$V_I = V_{CC}$ or GND	5.5	_	_	±1.0	μΑ
I <sub>CC</sub>	quiescent supply current	$V_I = V_{CC}$ or GND; $I_O = 0$	5.5	_	_	80	μΑ
$\Delta I_{CC}$	additional quiescent supply current per input	$V_I = V_{CC} - 2.1 \text{ V other}$ inputs at $V_{CC}$ or GND; $I_O = 0$	4.5 to 5.5	_	_	490	μА

### Note

1. All typical values are measured at  $T_{amb}$  = 25 °C.

### Remark to HCT types

The value of additional quiescent supply current ( $\Delta I_{CC}$ ) for a unit load of 1 is given here. To determine  $\Delta I_{CC}$  per input, multiply this value by the unit load coefficient shown in the table.

INPUT	UNIT LOAD COEFFICIENT
nD	0.70
nRD	0.70
nŜD	0.80
nCP	0.80

## Dual D-type flip-flop with set and reset; positive-edge trigger

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### **AC CHARACTERISTICS**

### Family 74HC

GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF.

CVMDOL	DADAMETED	TEST CONDIT	IONS	BAINI	TVD	MAX.	UNIT	
SYMBOL	PARAMETER	WAVEFORMS	V <sub>CC</sub> (V)	MIN.	TYP.			
T <sub>amb</sub> = -40 to	o +85 °C	,	'	1	'	1	•	
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay	see Fig.7	2.0	_	47	220	ns	
	nCP to nQ, nQ		4.5	_	17	44	ns	
			6.0	_	14	37	ns	
	propagation delay	see Fig.8	2.0	_	50	250	ns	
	$n\overline{S}D$ to $nQ$ , $n\overline{Q}$		4.5	_	18	50	ns	
			6.0	_	14	43	ns	
	propagation delay	see Fig.8	2.0	_	52	250	ns	
nRD to nQ, nQ	nRD to nQ, nQ		4.5	_	19	50	ns	
		6.0	_	15	43	ns		
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Fig.7	2.0	_	19	95	ns	
				4.5	_	7	19	ns
		6.0	_	6	16	ns		
tw	clock pulse width	see Fig.7	2.0	100	19	_	ns	
	HIGH or LOW		4.5	20	7	_	ns	
			6.0	17	6	_	ns	
	set or reset pulse width	see Fig.8	2.0	100	19	_	ns	
	LOW		4.5	20	7	_	ns	
			6.0	17	6	_	ns	
t <sub>rem</sub>	removal time set or	see Fig.8	2.0	40	3	_	ns	
	reset		4.5	8	1	_	ns	
			6.0	7	1	_	ns	
su	set-up time nD to nCP	see Fig.7	2.0	75	6	_	ns	
			4.5	15	2	_	ns	
			6.0	13	2	_	ns	
h	hold time nCP to nD	see Fig.7	2.0	3	-6	_	ns	
			4.5	3	-2	_	ns	
			6.0	3	-2	_	ns	
: max	maximum clock pulse	see Fig.7	2.0	4.8	23	_	MHz	
	frequency		4.5	24	69	_	MHz	
			6.0	28	82	_	MHz	

# Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

OVMDOL	PARAMETER	TEST CONDITIONS			TVD	MAY	
SYMBOL		WAVEFORMS	V <sub>CC</sub> (V)	MIN.	TYP.	MAX.	UNIT
T <sub>amb</sub> = -40 to	+125 °C		•		•		
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay	see Fig.7	2.0	_	_	265	ns
	nCP to nQ, $n\overline{Q}$		4.5	_	_	53	ns
			6.0	_	_	45	ns
	propagation delay	see Fig.8	2.0	_	_	300	ns
	$n\overline{S}D$ to $nQ$ , $n\overline{Q}$		4.5	_	_	60	ns
			6.0	_	_	51	ns
	propagation delay	see Fig.8	2.0	_	_	300	ns
	$n\overline{R}D$ to $nQ$ , $n\overline{Q}$		4.5	_	_	60	ns
			6.0	_	_	51	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Fig.7	2.0	_	_	110	ns
			4.5	_	_	22	ns
			6.0	_	_	19	ns
t <sub>W</sub>	clock pulse width HIGH or LOW	see Fig.7	2.0	120	_	_	ns
			4.5	24	_	_	ns
			6.0	20	_	_	ns
t <sub>W</sub>	set or reset pulse width	see Fig.8	2.0	120	_	_	ns
	LOW		4.5	24	_	_	ns
			6.0	20	_	_	ns
t <sub>rem</sub>	removal time set or	see Fig.8	2.0	45	_	_	ns
	reset		4.5	9	_	_	ns
			6.0	8	_	_	ns
t <sub>su</sub>	set-up time nD to nCP	see Fig.7	2.0	90	_	_	ns
			4.5	18	_	_	ns
			6.0	15	_	_	ns
t <sub>h</sub>	hold time nCP to nD	see Fig.7	2.0	3	_	_	ns
			4.5	3	_	_	ns
			6.0	3	_	_	ns
f <sub>max</sub>	maximum clock pulse	see Fig.7	2.0	4.0	_	_	MHz
	frequency		4.5	20	_	_	MHz
			6.0	24	_	_	MHz

# Dual D-type flip-flop with set and reset; positive-edge trigger

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Family 74HCT

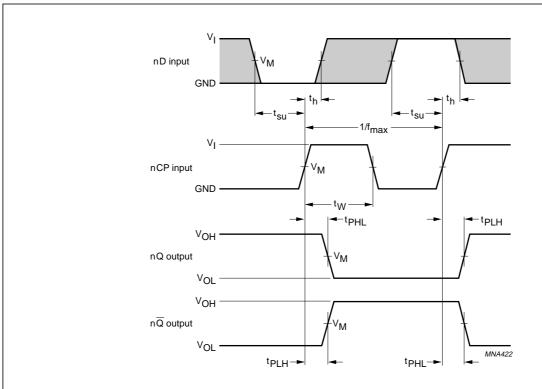
GND = 0 V;  $t_r = t_f = 6$  ns;  $C_L = 50$  pF.

CVMDOL	DADAMETED	TEST CONDIT	IONS	NAIN!	TVD	MAY	
SYMBOL	PARAMETER	WAVEFORMS	V <sub>CC</sub> (V)	MIN.	TYP.	MAX.	UNIT
T <sub>amb</sub> = -40 to	o +85 °C		'				!
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nCP to nQ, $n\overline{Q}$	see Fig.7	4.5	_	18	44	ns
	propagation delay nSD to nQ, nQ	see Fig.8	4.5	_	23	50	ns
	propagation delay nRD to nQ, nQ	see Fig.8	4.5	_	24	50	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Fig.7	4.5	_	7	19	ns
t <sub>W</sub>	clock pulse width HIGH or LOW	see Fig.7	4.5	23	9	_	ns
	set or reset pulse width LOW	see Fig.8	4.5	20	9	-	ns
t <sub>rem</sub>	removal time set or reset	see Fig.8	4.5	8	1	-	ns
t <sub>su</sub>	set-up time nD to nCP	see Fig.7	4.5	15	5	_	ns
t <sub>h</sub>	hold time nCP to nD	see Fig.7	4.5	+3	-3	_	ns
f <sub>max</sub>	maximum clock pulse frequency	see Fig.7	4.5	22	54	_	MHz
$T_{amb} = -40 \text{ to}$	o +125 °C		•		•	•	
t <sub>PHL</sub> /t <sub>PLH</sub>	propagation delay nCP to nQ, $n\overline{Q}$	see Fig.7	4.5	_	_	53	ns
	propagation delay nSD to nQ, nQ	see Fig.8	4.5	_	_	60	ns
	propagation delay nRD to nQ, nQ	see Fig.8	4.5	_	_	60	ns
t <sub>THL</sub> /t <sub>TLH</sub>	output transition time	see Fig.7	4.5	_	_	22	ns
t <sub>W</sub>	clock pulse width HIGH or LOW	see Fig.7	4.5	27	_	-	ns
	set or reset pulse width LOW	see Fig.8	4.5	24	-	-	ns
t <sub>rem</sub>	removal time set or reset	see Fig.8	4.5	9	_	-	ns
t <sub>su</sub>	set-up time nD to nCP	see Fig.7	4.5	18	_	_	ns
t <sub>h</sub>	hold time nCP to nD	see Fig.7	4.5	3	_	_	ns
f <sub>max</sub>	maximum clock pulse frequency	see Fig.7	4.5	18	-	-	MHz

### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

#### **AC WAVEFORMS**



The shaded areas indicate when the input is permitted to change for predictable output performance.

74HC74:  $V_M$  = 50%;  $V_I$  = GND to  $V_{CC}$ .

74HCT74:  $V_M = 1.3 \text{ V}$ ;  $V_I = \text{GND to 3 V}$ .

Fig.7 The clock (nCP) to output (nQ,  $n\overline{Q}$ ) propagation delays, the clock pulse width, the nD to nCP set-up, the nCP to nD hold times, the output transition times and the maximum clock pulse frequency.

### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

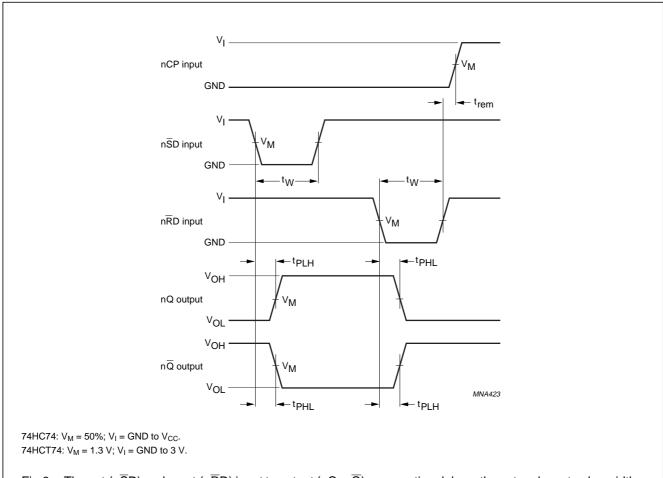
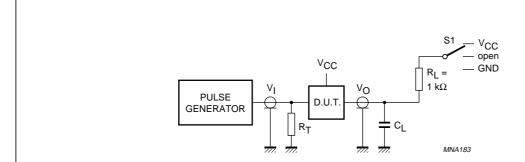


Fig.8 The set  $(n\overline{S}D)$  and reset  $(n\overline{R}D)$  input to output  $(nQ, n\overline{Q})$  propagation delays, the set and reset pulse widths and the  $n\overline{R}D$ ,  $n\overline{R}D$  to nCP removal time.

### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74



TEST	S1
t <sub>PZH</sub>	GND
t <sub>PZL</sub>	V <sub>CC</sub>
t <sub>PHZ</sub>	GND
t <sub>PLZ</sub>	V <sub>CC</sub>

Definitions for test circuit:

R<sub>L</sub> = Load resistor.

 $\ensuremath{C_L}$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

Fig.9 Load circuitry for switching times.

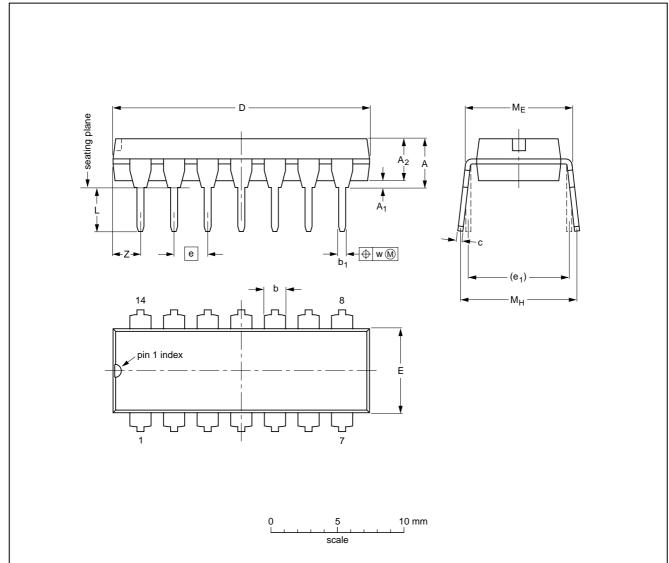
## Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

### **PACKAGE OUTLINES**

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



#### DIMENSIONS (inch dimensions are derived from the original mm dimensions)

	•														
UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	Мн	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.02	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

#### Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

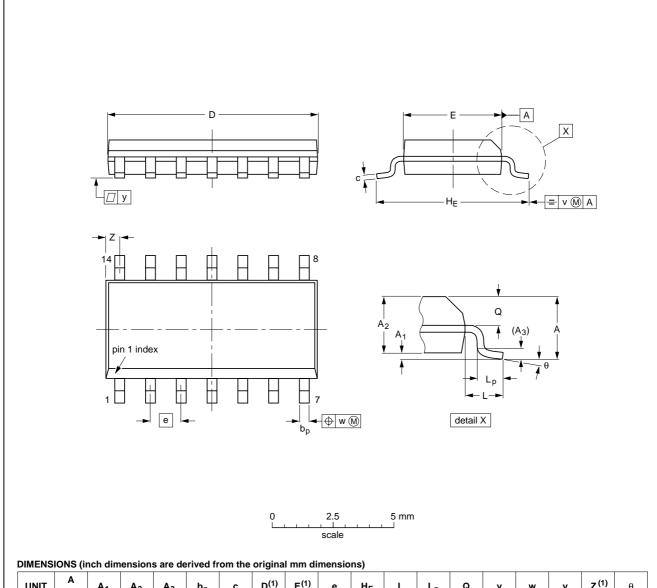
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT27-1	050G04	MO-001	SC-501-14		<del>99-12-27</del> 03-02-13

## Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UN	IT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	z <sup>(1)</sup>	θ
mr	n	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inch	es	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

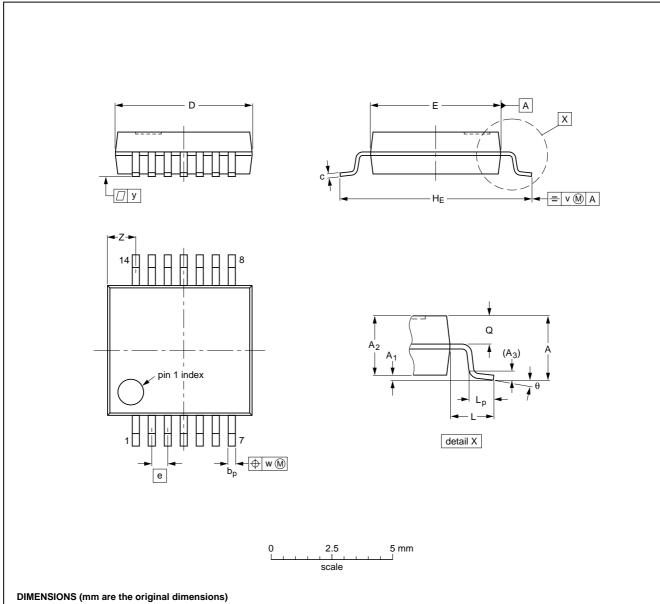
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			<del>99-12-27</del> 03-02-19

### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT337-1		MO-150			<del>99-12-27</del> 03-02-19

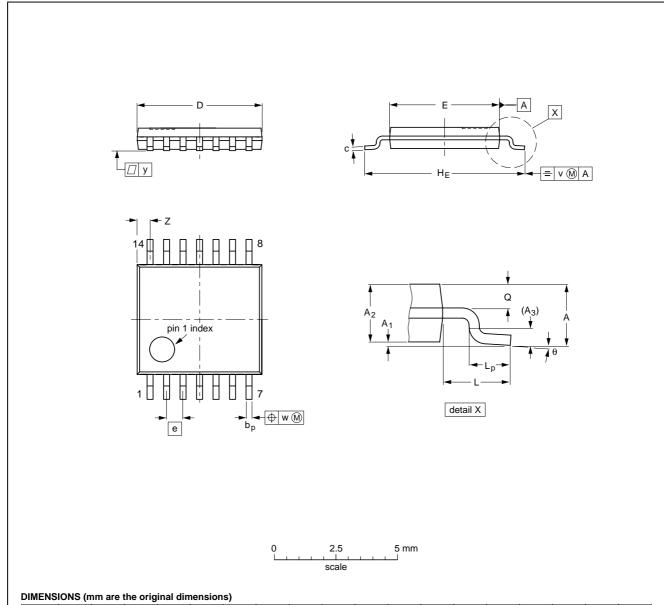
2003 Jul 10 18

## Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



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UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

#### Notes

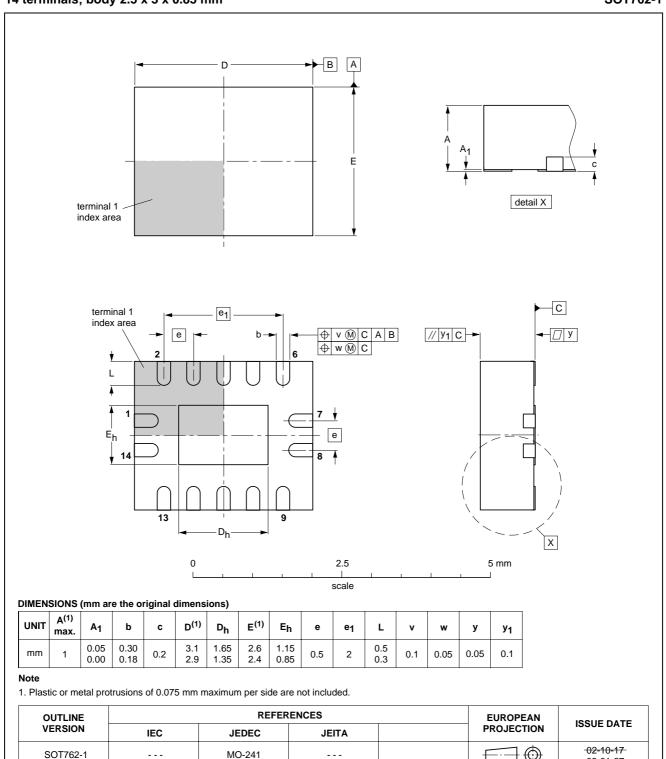
- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT402-1		MO-153			<del>99-12-27</del> 03-02-18

### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; SOT762-1 14 terminals; body 2.5 x 3 x 0.85 mm



OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT762-1		MO-241			<del>02-10-17</del> 03-01-27

2003 Jul 10 20

### Dual D-type flip-flop with set and reset; positive-edge trigger

74HC74; 74HCT74

#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Printed in The Netherlands

613508/03/pp22

Date of release: 2003 Jul 10

Document order number: 9397 750 11259

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